

# An Accurate Model for Pull-in Voltage of Circular Diaphragm Capacitive Micromachined Ultrasonic Transducers (CMUT)

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# Research Objective

- Develop an accurate Analytical Model to calculate **Pull-in Voltage** of a CMUT device built with Circular diaphragm.

CMUT devices are a type of MEMS capacitive ultrasonic sensors characterized by small device dimensions.

The model takes into account

- *Non-linear stretching of the diaphragm due to Large Deflection,*
- *Built-in Residual Stress of the membrane,*
- *Bending Stress, and*
- *the Fringing Field effect, and*
- *the non-linearity of the Electrostatic Field*

# Presentation Outline

- **MOTIVATION**
- **BASIC DEVICE STRUCTURE AND OPERATION**
- **LIMITATIONS IN EXISTING MODELS**
- **SOLUTION APPROACH**
- **MODEL DEVELOPMENT**
- **MODEL VALIDATION**
- **CONCLUSIONS**

# Motivation

## ● CMUT devices has

### ➤ Wide Range of Applications

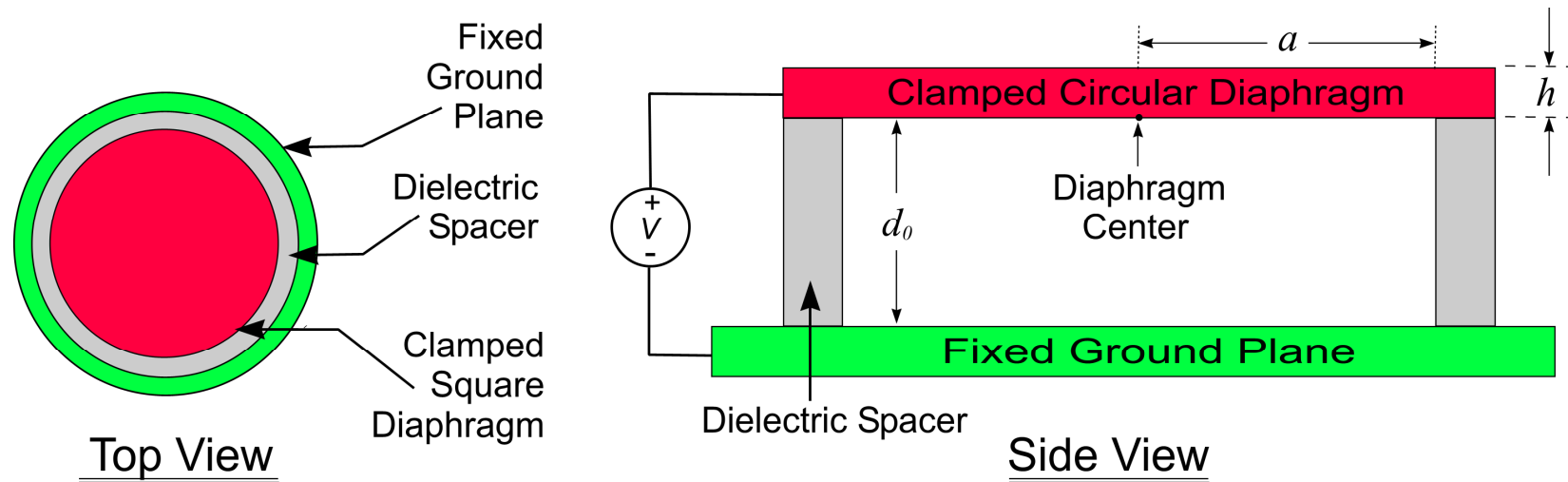
- Biomedical Imaging
- Automotive Collision Avoidance Radar System
- Nondestructive Testing
- Microphones

### ➤ Superior performance over traditional piezoelectric transducers

- low temperature sensitivity
- high signal sensitivity
- wide bandwidth
- very high level of integration (low cost)

➤ Estimating **Pull-in Voltage**  $V_{\text{Pull-in}}$  and the **Plate Travel Distance**  $x_p$  before pull-in effect is required for the successful design of electrostatic actuators, switches, varactors, and sensors.

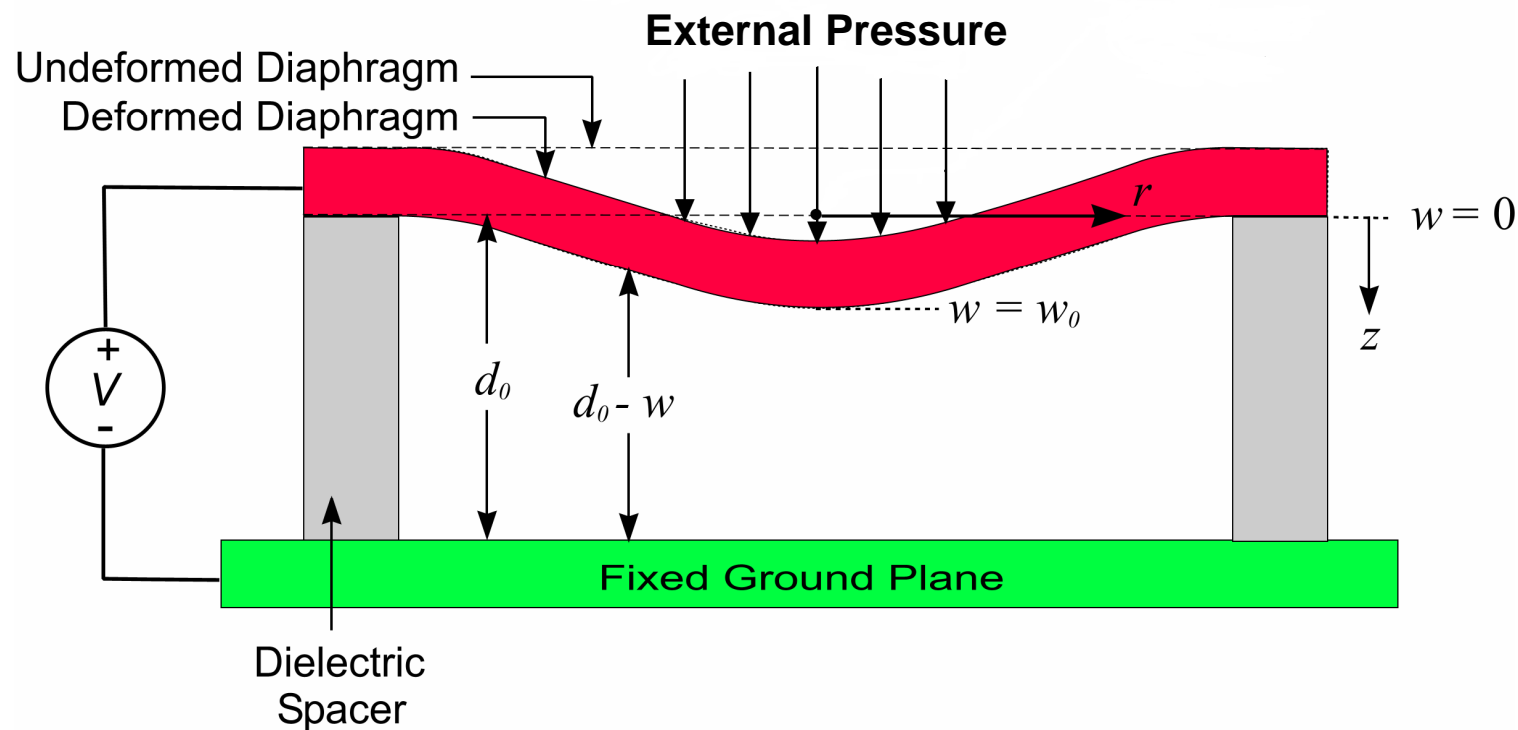
# Basic Device Structure



**Basic structure of a CMUT device  
with a circular diaphragm.**

# Operation Principle

**Diaphragm deformation after subject to an external pressure.**



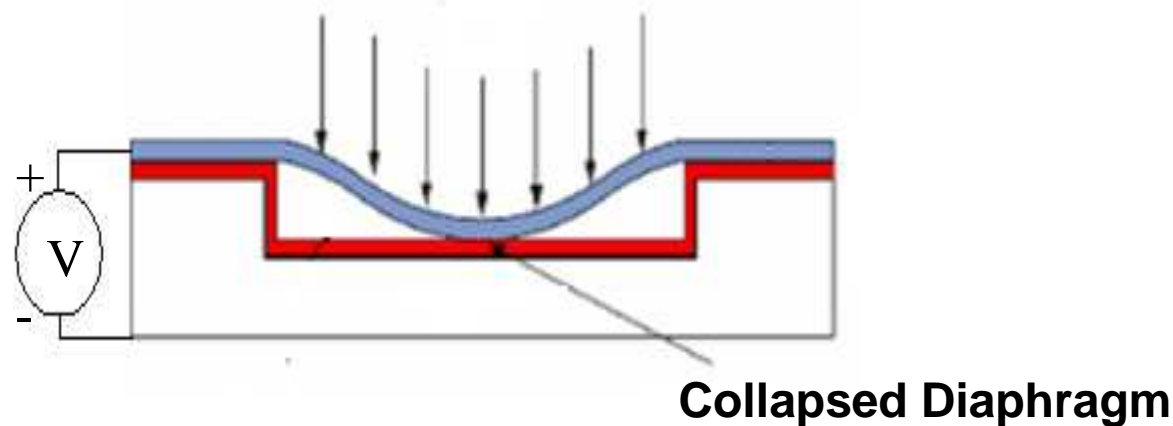
➤ At equilibrium, Electrostatic Attraction Force is balanced by the Elastic Restoring Force of the Diaphragm

# Diaphragm Collapse and Pull-in Voltage ( $V_{\text{Pull-in}}$ )

For  $V < V_{\text{Pull-in}}$ , *Electrostatic Force = Elastic Restoring Force*

For  $V > V_{\text{Pull-in}}$ , *Electrostatic Force > Elastic Restoring Force*

Diaphragm collapses under excessive electrostatic pressure

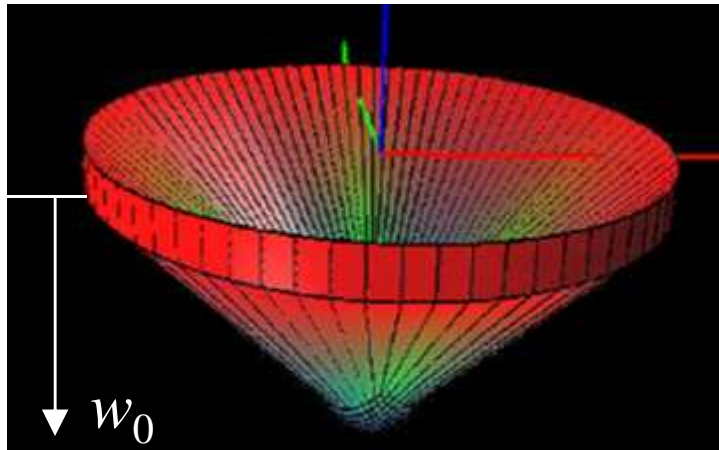


# Limitations in Existing Models: Parallel Plate Approximation

- Existing models are based on **parallel plate approximation**
- Assumes piston-like motion of the diaphragm and predicts pull-in when center deflection reaches  $\frac{1}{3}$  of the airgap

$$w_{0-PI} = 1/3d_0 \quad (1)$$

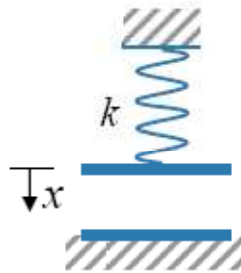
← Pull-in travel of the diaphragm



*Deflection of  
Circular Diaphragm  
in Intellisuite*

# Limitations in Existing Models: Spring Hardening Effect

- Does not account for **spring hardening effect** due to non-linear stretching of the diaphragm under **large deflection**, more pronounced in **thin diaphragms** as in CMUTs



Force  $F = kx$ ,  $k$  is the spring constant

Not valid for large deflection

- Spring hardening causes the Pull-in Voltage to go up and center deflection can be as high as 50% of the airgap

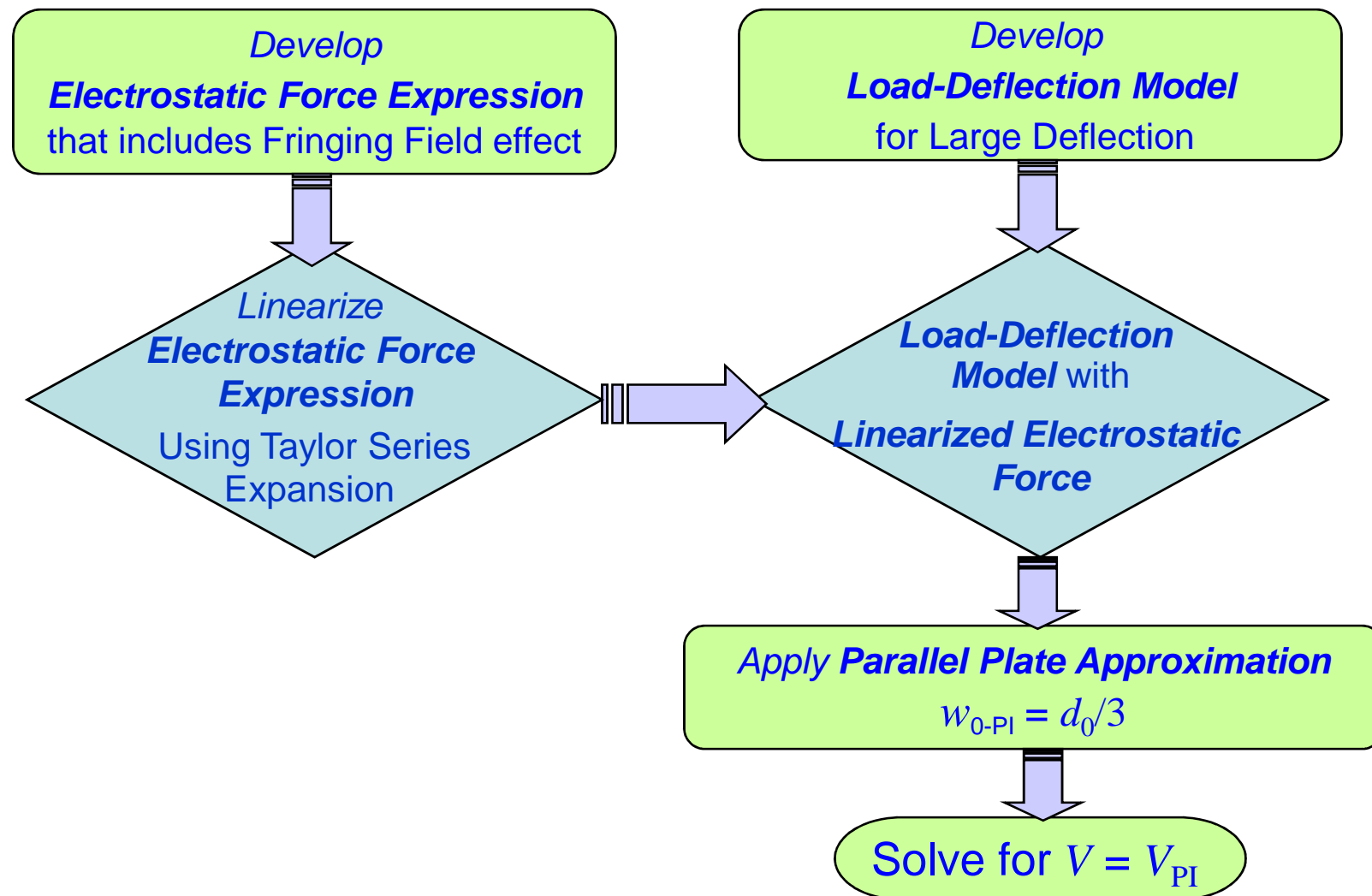
$$w_{0-PI} \approx 0.5d_0 \quad (2)$$

- Does not take into account the effect of **Poisson ratio**

# Limitations in Existing Models: Fringing Field Effect

- Existing model does not take into account the effect due to **Fringing Fields**
- Fringing Field effect causes **spring softening effect** of the diaphragm, lowering the pull-in voltage
- The effect is more pronounced in sensors with small diaphragm, such as in CMUT devices
- **Above simplifications result in an error as high as 20% when compared to experimental and FEA results**

# Solution Approach



# Model Development



**Load-Deflection Model**

# Assumptions

- As the deflection of membrane is very small compared to its side-length, the *forces on the membrane are assumed to always act perpendicular* to the diaphragm surface.
- *The deflection of the membrane is assumed to be a quasistatic process*, i.e., the dynamic effects due to its motion (such as inertia force, damping force, etc) are not considered in this analysis.

# Load-Deflection Model of a Circular Membrane

Load-deflection model for circular membrane, subject to **large deflection**, due to an applied **uniform external pressure**  $P$ :

$$P = \left[ \frac{4\sigma_0 h}{a^2} + \frac{64D}{a^4} \right] w_o + \left[ \frac{128\alpha D}{h^2 a^4} \right] w_o^3 \quad (3)$$

Combined Stiffness  
due to Bending  
and residual stress

Stiffness of the  
membrane due to the  
nonlinear stretching

$h$  → Membrane Thickness

$a$  → Membrane radius

$D = \frac{\tilde{E}h^3}{12(1-\nu^2)}$  → Flexural rigidity

$\sigma_0$  → Residual Stress

$\tilde{E} = \frac{E}{1-\nu^2}$  → Effective Young's modulus

$E$  → Young's modulus

$\nu$  → Poisson ratio

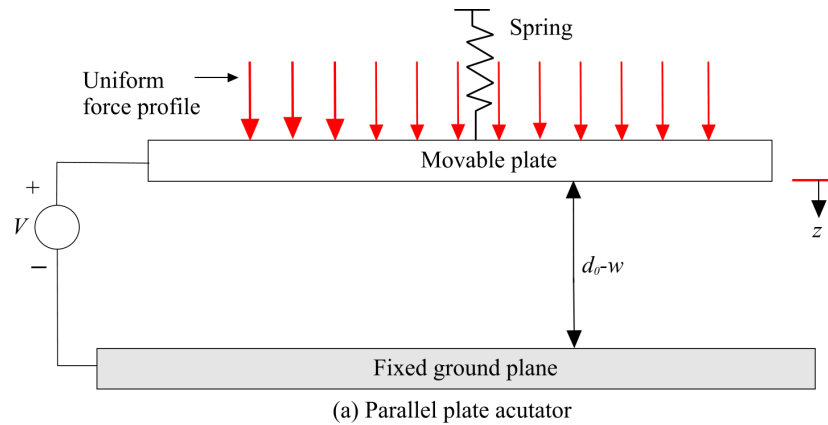
$\alpha = \frac{7505+4250\nu-2791\nu^2}{35280}$  → Poisson ratio dependent empirical parameter

\* S. Timoshenko and S. Woinowsky-Krieger, *Theory of Plates and Shells*, McGraw-Hill Book Company New York, 1959, pp. 397-428.  
M. Gad-El-Haq (Editor), *MEMS Handbook*, Second Edition, 2002, CRC Press, Boca Raton, pp. 3-1-3-4.

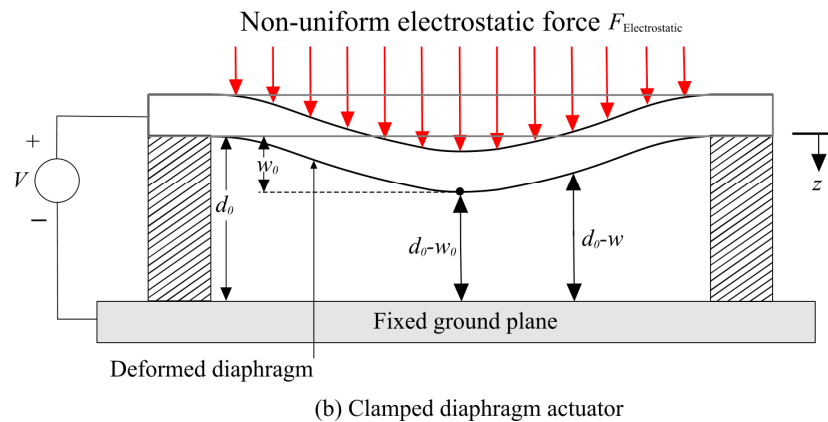
# Model Development

**Electrostatic Pressure**

# Electrostatic Force Profile



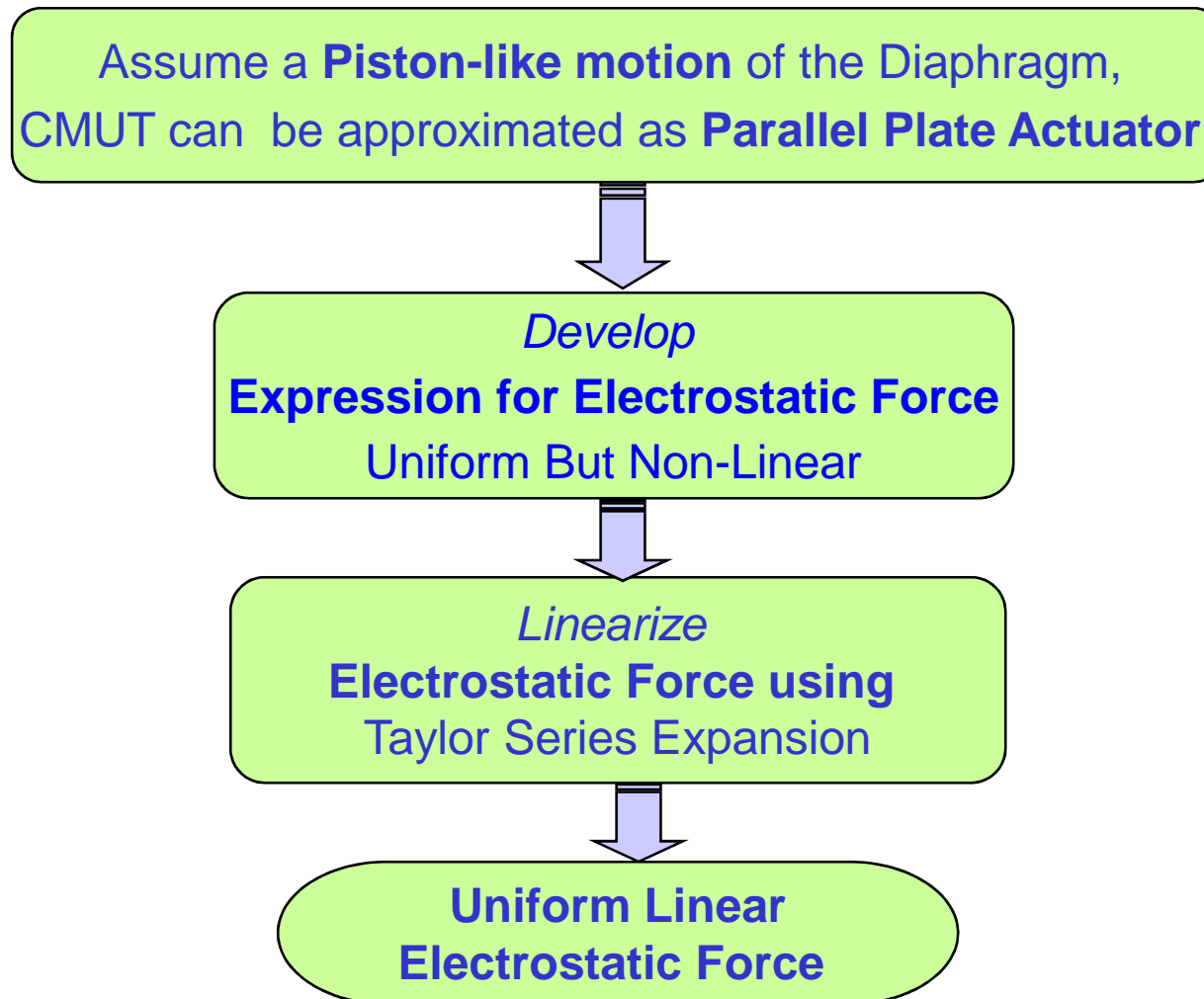
Electrostatic force profile in a parallel plate geometry:  
Uniform but Non-Linear



Electrostatic force profile in a deformed clamped square diaphragm:  
Non-Uniform and Non-Linear

- ➡ No known solution for Load-Deflection Model exist with non-linear non-uniform electrostatic force

# Solution Approach for Non-Linear Non-Uniform Force



# Capacitance: Undelected Diaphragm

❖ Capacitance of undelected diaphragm:

$$C = C_0 (1 + C_{ff})$$

$$= \frac{a^2 \pi \epsilon_r \epsilon_0}{d_0} \left\{ 1 + \frac{2d_0}{\pi \epsilon_r a} \left[ \ln \left( \frac{a}{2d_0} \right) + (1.41 \epsilon_r + 1.77) + \frac{d_0}{a} (0.268 \epsilon_r + 1.65) \right] \right\} \quad (4)$$

$$C_0 = \epsilon_0 \epsilon_r \pi a^2 / d_0 \quad \longrightarrow \quad \text{Parallel plate capacitance} \quad (5)$$

$$C_{ff} \cong \frac{2d_0}{\pi \epsilon_r a} \left[ \ln \left( \frac{a}{2d_0} \right) + (1.41 \epsilon_r + 1.77) + \frac{d_0}{a} (0.268 \epsilon_r + 1.65) \right] \quad \longrightarrow \quad \text{Fringing Field Factor} \quad (6)$$

$$\epsilon_0 = 8.854 \times 10^{-14} \quad \longrightarrow \quad \text{Dielectric Permittivity of free space}$$

$$\epsilon_r = 1 \text{ (for air)} \quad \longrightarrow \quad \text{Relative Permittivity of the medium} \quad (7)$$

\* W. C. Chew and J. A. Kong, "Effects of Fringing Fields on the Capacitance of Circular Microstrip Disk", *IEEE Transactions on Microwave Theory and Techniques*, Vol. 28, No. 2, pp. 98-104, Feb. 1980.

# Capacitance: Deflected Diaphragm

- ❖ Capacitance of deflected diaphragm for any deflection  $w$ :

$$C_{\text{PP-Piston}} \cong \frac{a^2 \pi \epsilon_r \epsilon_0}{d} \left\{ 1 + \frac{2d}{\pi \epsilon_r a} \left[ \ln \left( \frac{a}{2d} \right) + (1.41 \epsilon_r + 1.77) + \frac{d}{a} (0.268 \epsilon_r + 1.65) \right] \right\} \quad (8)$$

where,  $d = d_0 - w$ , is the separation between the diaphragm and the backplate

<i>Assumption made</i>	Piston-like motion of the diaphragm (Parallel Plate Approximation)
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- ❖  $\epsilon_r = 1$  (for air), substituting in (8) the Capacitance expression becomes:

$$C_{\text{pp-piston}} \cong \frac{a^2 \pi \epsilon_0}{d_0 - w} \left\{ 1 + \frac{2(d_0 - w)}{\pi a} \left[ \ln \left( \frac{a}{2(d_0 - w)} \right) + \frac{1.918(d_0 - w)}{a} + 3.18 \right] \right\} \quad (9)$$

# Electrostatic Force

- The developed *Electrostatic Force* after applying a bias voltage  $V$

$$F_{\text{electrostatic}} = -\frac{d}{dz} \left( \frac{1}{2} C_{\text{pp-piston}} V^2 \right) = \left[ \frac{\pi a^2}{2(d_o - w)^2} + \frac{a}{d_o - w} - 1.918 \right] \epsilon_0 V^2 \quad (10)$$

- After Linearizing using Taylor series expansion method about the zero deflection point and rearranging the terms:

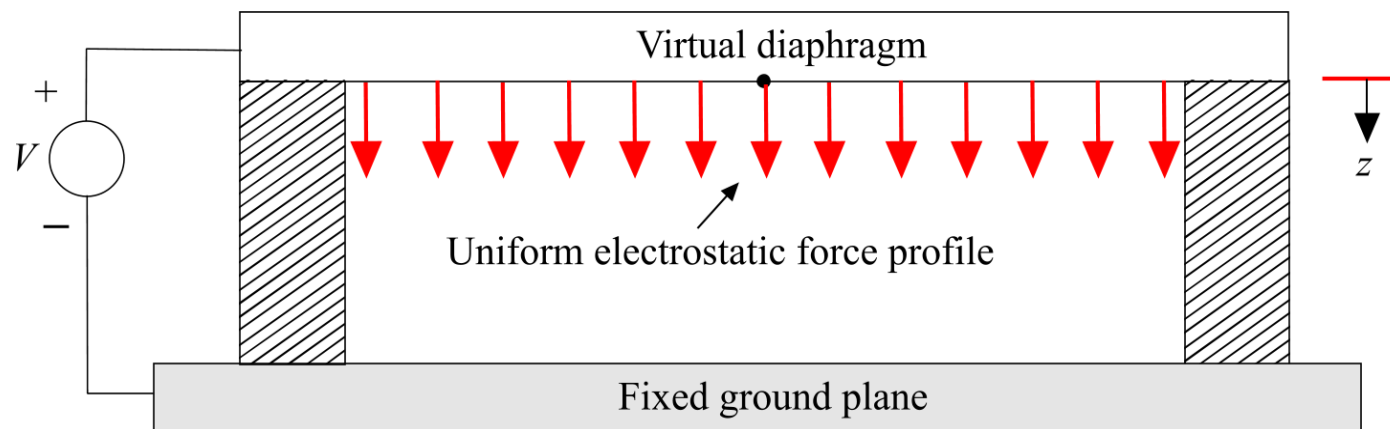
$$F_{\text{electrostatic}} = \epsilon_0 \pi a^2 V^2 \left[ \frac{1}{2d_o^2} + \frac{1}{\pi a d_o} + \frac{1.918}{\pi a^2} \right] + \epsilon_0 \pi a^2 V^2 \left[ \frac{1}{d_o^3} + \frac{1}{\pi a d_o^2} \right] w \quad (11)$$

# Electrostatic Pressure

- Replacing  $w = w_0$ , the *Electrostatic Pressure* is given by,

$$P_{\text{electrostatic}} = \frac{F_{\text{electrostatic}}}{A} = \epsilon_0 V^2 \left[ \frac{1}{2d_0^2} + \frac{1}{\pi a d_0} + \frac{1.918}{\pi a^2} \right] + \epsilon_0 V^2 \left[ \frac{1}{d_0^3} + \frac{1}{\pi a d_0^2} \right] w_0 \quad (12)$$

Load-deflection model due to electrostatic pressure  
 Yields **uniform linear electrostatic pressure profile**



Virtual planar diaphragm after linearizing the electrostatic force about the zero deflection point of the diaphragm center

# Model Development



**Pull-in Voltage**

# Pressures on Diaphragm at Pull-in Equilibrium

- For Parallel Plate Actuator, diaphragm travel at pull-in

$$w_{0-PI} = d_0/3 \quad (1)$$

- At *pull-in equilibrium*,

- 1. Electrostatic Pressure  $P_{PI-electrostatic}$**  (from electrostatic pressure expression)  
[after substituting  $w_0=d_0/3$  in (12)]:

$$P_{PI-electrostatic} = \epsilon_0 V_{PI}^2 \left[ \frac{1}{2d_0^2} + \frac{1}{\pi a d_0} + \frac{1.918}{\pi a^2} \right] + \epsilon_0 V_{PI}^2 \left[ \frac{1}{d_0^3} + \frac{1}{\pi a d_0^2} \right] \left( \frac{d_0}{3} \right)$$

(13)

- 2. Elastic Restoring Pressure  $P_{PI-elastic}$**  (from load-deflection model)  
[after substituting  $w_0=d_0/3$  in (3)]

$$P_{PI-elastic} = \left[ \frac{64D}{a^4} + \frac{4\sigma h}{a^2} \right] \left( \frac{d_0}{3} \right) + \frac{128\alpha D}{h^2 a^4} \left( \frac{d_0}{3} \right)^3$$

(14)

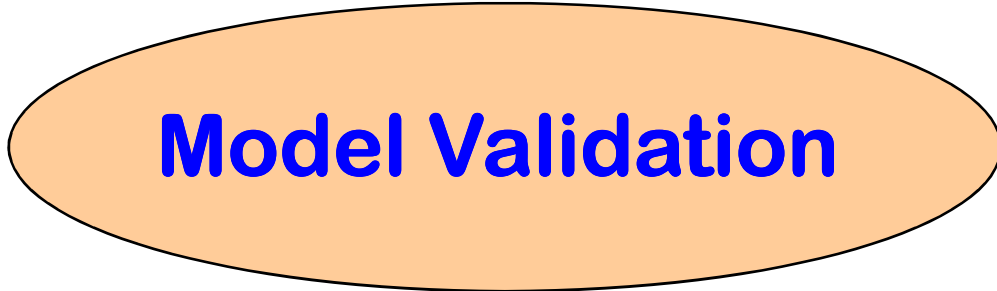
# Pull-in Voltage

- At *pull-in equilibrium*, the **electrostatic pressure** is just counterbalanced by the **elastic restoring pressure**

$$P_{\text{PI-electrostatic}} = P_{\text{PI-elastic}} \quad (15)$$

- (13) and (14) can be solved simultaneously to yield the closed-form model for the pull-in voltage  $V_{\text{PI}}$  for the circular diaphragm as:

$$V_{\text{PI}} = \sqrt{\frac{\left[ \frac{64D}{a^4} + \frac{4\sigma h}{a^2} \right] \left( \frac{d_0}{3} \right) + \frac{128\alpha D}{h^2 a^4} \left( \frac{d_0}{3} \right)^3}{\epsilon_0 \left[ \frac{5}{6d_0^2} + \frac{4}{3\pi a d_0} + \frac{1.918}{\pi a^2} \right]}} \quad (16)$$

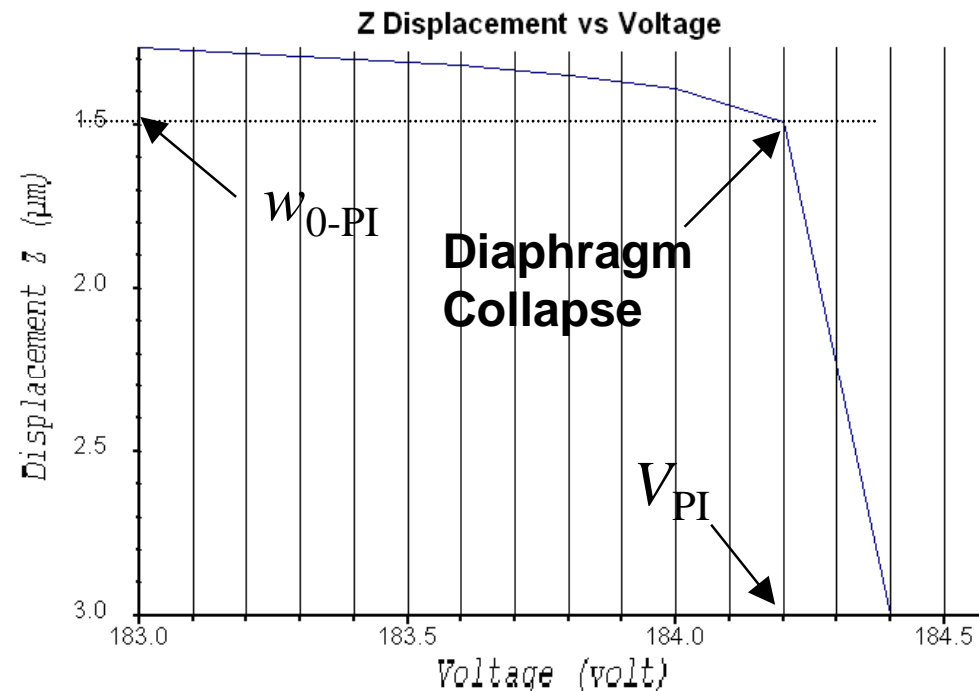
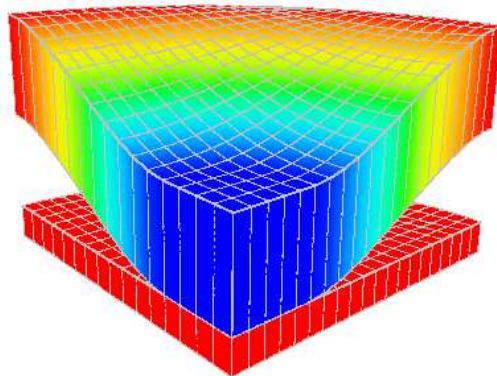


**Model Validation**

# Finite Element Analysis Using IntelliSuite

**Table I. Device Specifications Used in FEA Simulation**

Parameter	Unit	Value
Diaphragm Radius ( $a$ )	$\mu\text{m}$	250
Diaphragm Thickness ( $h$ )	$\mu\text{m}$	1-3
Airgap Thickness ( $d_0$ )	$\mu\text{m}$	2-3
Young's Modulus ( $E$ )	GPa	169
Poisson Ratio ( $\nu$ )	-	0.3



(Right) Screen capture of the diaphragm collapse after carrying out a 3-D electromechanical FEA using IntelliSuite. ( $h = 3 \mu\text{m}$ ,  $d_0 = 3 \mu\text{m}$ ,  $\sigma_0 = 100 \text{ MPa}$ ).

# Model Validation

## Table II. Pull-in Voltage Comparison

Diaphragm thickness,  $h = 1 \mu\text{m}$ , Airgap thickness,  $d_0 = 2 \mu\text{m}$

Residual stress (MPa)	(V)			$\Delta\%$	
	New Model	Ref. [14]	FEA	FEA - New model	FEA - Ref. [14]
0	11.03	9.89	12.4	10.98	20.24
100	49.24	50.48	49.9	1.3	1.16
250	76.69	77.88	76.86	0.22	1.32
350	90.46	91.56	90.4	0.074	1.28
<b>Diaphragm thickness, <math>h = 1 \mu\text{m}</math>, Airgap thickness, <math>d_0 = 3 \mu\text{m}</math></b>					
0	22.38	18.17	28.04	20.17	35.2
100	90.88	92.83	91.4	0.56	1.46
250	141.06	143.07	139.9	0.82	2.26
350	166.3	168.2	164.4	1.15	2.31

Ref [14] P. M. Osterberg, "Electrostatically Actuated Microelectromechanical Test Structures for Material property Measurements," *Ph.D. Dissertation*, MIT, Cambridge, MA, 1995, pp. 52-87.

# Model Validation

## Table III. Pull-in Voltage Comparison

Diaphragm thickness,  $h = 2 \mu\text{m}$ , Airgap thickness,  $d_0 = 3 \mu\text{m}$

Residual stress (MPa)	(V)			$\Delta\%$	
	New Model	Ref. [14]	FEA	FEA - New model	FEA - Ref. [14]
0	55.03	51.39	57.6	4.45	10.77
100	136.18	141.18	138.4	1.6	2.0
250	204.5	211.24	205.6	0.53	2.74
350	239.45	246.53	239.8	0.15	2.8
<b>Diaphragm thickness, <math>h = 3 \mu\text{m}</math>, Airgap thickness, <math>d_0 = 3 \mu\text{m}</math></b>					
0	98.03	94.42	97.7	0.33	3.36
100	181.34	188.14	184.2	1.55	2.14
250	260.38	271.20	263.4	1.14	2.96
350	301.78	313.77	304.4	0.85	3.07

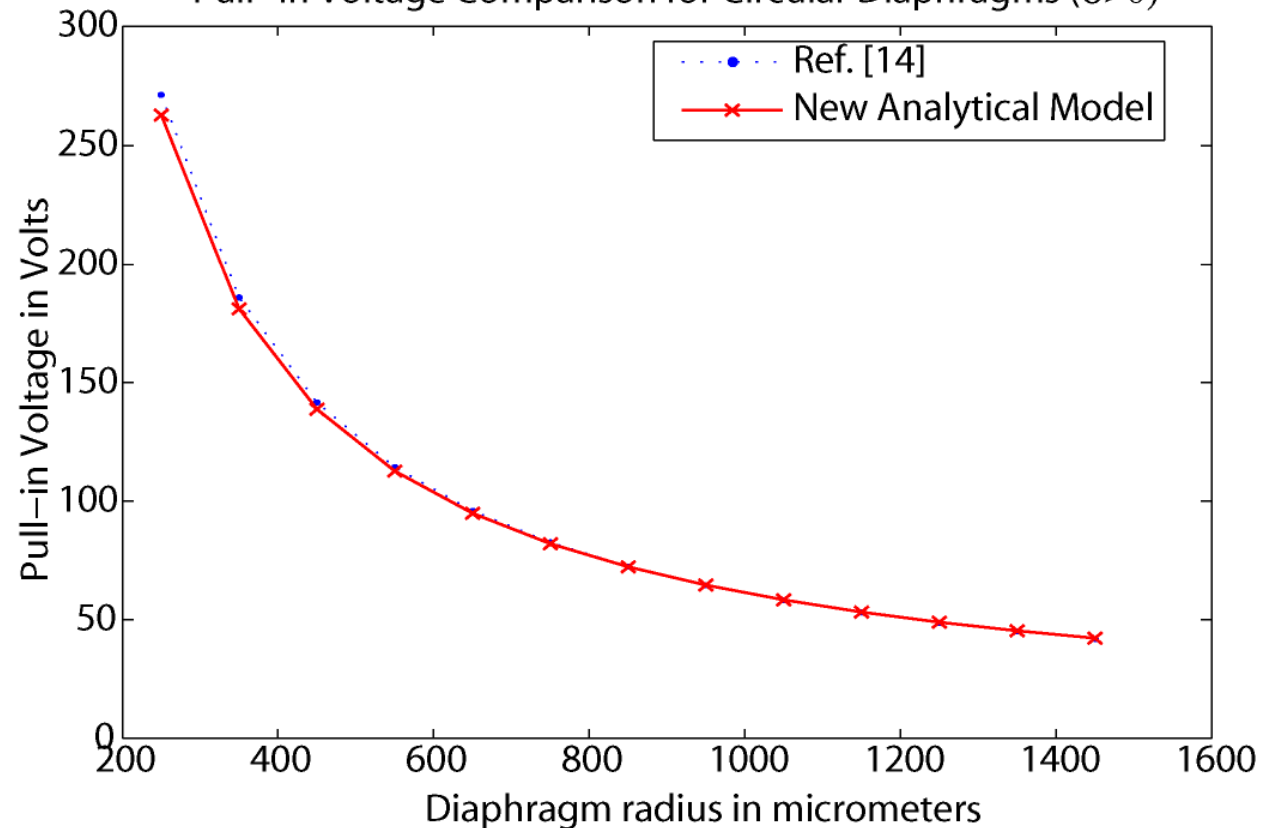
Ref [14] P. M. Osterberg, "Electrostatically Actuated Microelectromechanical Test Structures for Material property Measurements," *Ph.D. Dissertation*, MIT, Cambridge, MA, 1995, pp. 52-87.

# Model Validation

## Pull-in Voltage vs Diaphragm Radius ( $\sigma_0 > 0$ )

(Diaphragm thickness,  $h = 3 \mu\text{m}$ , Airgap thickness,  $d_0 = 3 \mu\text{m}$ , Residual stress  $\sigma_0 = 250 \text{ MPa}$ )

Pull-in Voltage Comparison for Circular Diaphragms ( $\sigma > 0$ )

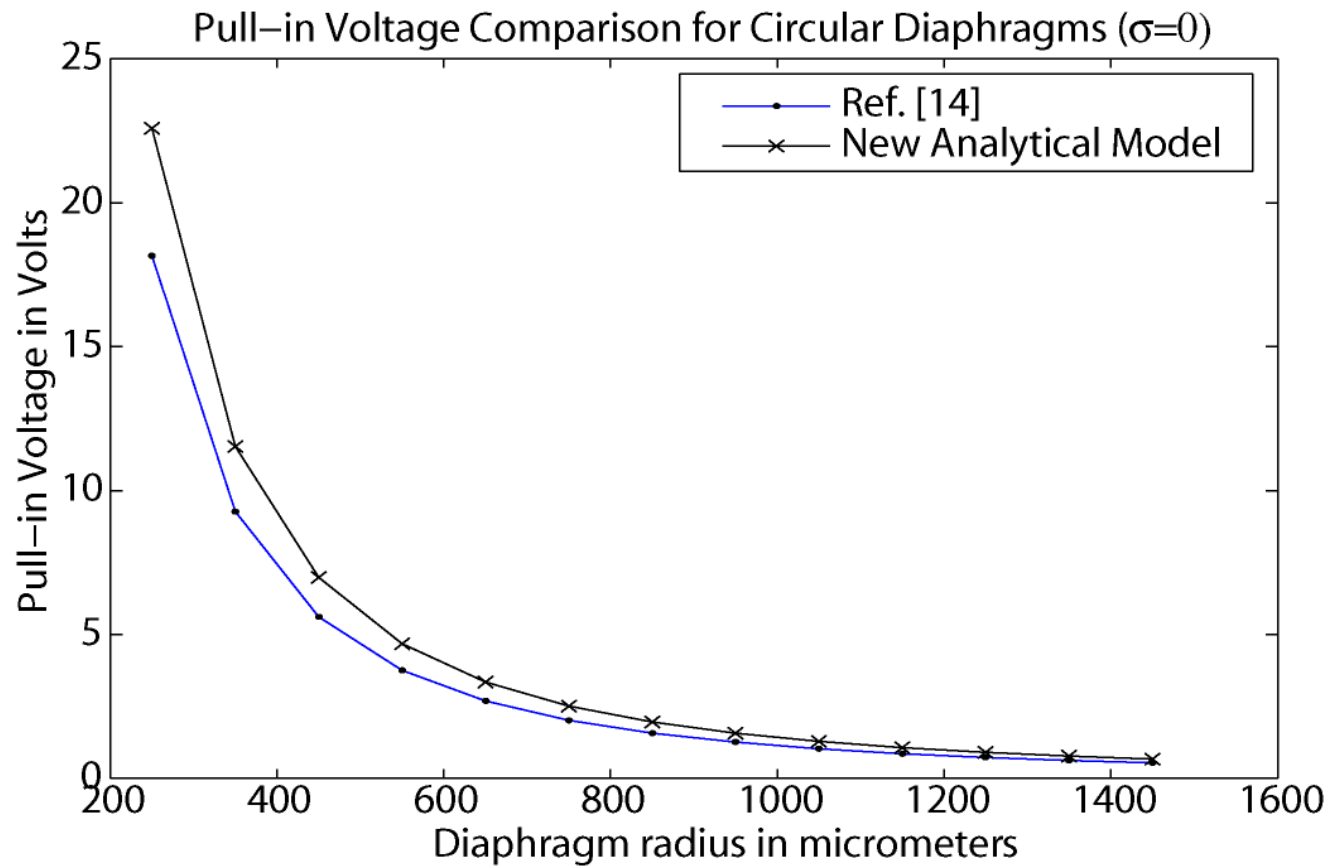


➡ Both the models merge at large diaphragm radius

# Model Validation

## Pull-in Voltage vs Diaphragm Radius ( $\sigma_0=0$ )

(Diaphragm thickness,  $h = 3 \mu\text{m}$ , Airgap thickness,  $d_0 = 3 \mu\text{m}$ , Residual stress  $\sigma_0=0$ )



➡ Both the models merge at large diaphragm radius

# Model Limitations

The new analytical method can provide very good approximation of pull-in voltage for the following limited cases:

- Both the electrodes are required to be parallel prior to any electrostatic actuation.
- The gap between the clamped diaphragm and the backplate should be small enough so that the Taylor series expansion about the zero deflection point doesn't introduce any significant error.
- The lateral dimensions of the diaphragm are required to be very large compared to the diaphragm's thickness and the airgap.

# Conclusions

- ☞ A **highly accurate closed-form model** for the **pull-in voltage** of a clamped circular diaphragm CMUT device is presented.
- ☞ The model is **simple, easy to use and fast**, and takes into account both the **non-linear stretching due to large deflection** and the **non-linearity of electrostatic field**.
- ☞ Excellent agreement with 3-D electromechanical FEA using IntelliSuite with a **maximum deviation of 1.6%** for diaphragms with residual stress
- ☞ Can also be easily extended to a *Clamped-edge Square Membrane*.
- ☞ Besides CMUTs, the Model will also be useful in **ensuring safe and efficient operation** of
  - MEMS capacitive type pressure sensors
  - MEMS based microphones
  - Touch mode pressure sensors
  - Other application areas where electrostatically actuated circular diaphragms are used.

*Thanks for your Patience*